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[International Rectifier \(Infineon Technologies Americas Corp.\)
IRF7752GTRPBF](#)

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sales@integrated-circuit.com

International IR Rectifier

PD-96151A

IRF7752GPbF

HEXFET® Power MOSFET

- Ultra Low On-Resistance
- Dual N-Channel MOSFET
- Very Small SOIC Package
- Low Profile (< 1.1mm)
- Available in Tape & Reel
- Lead-Free
- Halogen-Free

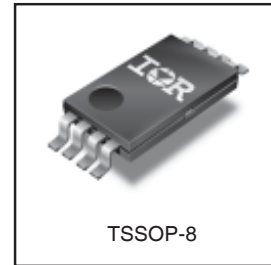
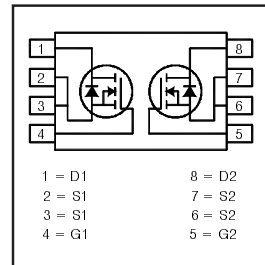
| V _{DS} | R _{DS(on)} max | I _D |
|-----------------|--------------------------------|----------------|
| 30V | 0.030 @ V _{GS} = 10V | 4.6A |
| | 0.036 @ V _{GS} = 4.5V | 3.9A |

Description

HEXFET® power MOSFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the ruggedized device design, that International Rectifier is well known for, provides the designer with an extremely efficient and reliable device for use in battery and load management.

The TSSOP-8 package, has 45% less footprint area of the standard SO-8. This makes the TSSOP-8 an ideal device for applications where printed circuit board space is at a premium.

The low profile (<1.1mm) of the TSSOP-8 will allow it to fit easily into extremely thin application environments such as portable electronics and PCMCIA cards.



Absolute Maximum Ratings

| | Parameter | Max. | Units |
|--|---|--------------|-------|
| V _{DS} | Drain- Source Voltage | 30 | V |
| I _D @ T _A = 25°C | Continuous Drain Current, V _{GS} @ 10V | 4.6 | A |
| I _D @ T _A = 70°C | Continuous Drain Current, V _{GS} @ 10V | 3.7 | |
| I _{DM} | Pulsed Drain Current ① | 37 | |
| P _D @ T _A = 25°C | Power Dissipation | 1.0 | W |
| P _D @ T _A = 70°C | Power Dissipation | 0.64 | |
| | Linear Derating Factor | 8.0 | mW/°C |
| V _{GS} | Gate-to-Source Voltage | ± 12 | V |
| T _J , T _{STG} | Junction and Storage Temperature Range | -55 to + 150 | °C |

Thermal Resistance

| | Parameter | Max. | Units |
|------------------|------------------------------|------|-------|
| R _{θJA} | Maximum Junction-to-Ambient③ | 125 | °C/W |

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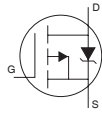
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Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|---------------------------------|--------------------------------------|------|-------|-------|---------------------|--|
| $V_{(BR)DSS}$ | Drain-to-Source Breakdown Voltage | 30 | — | — | V | $V_{GS} = 0V, I_D = -250\mu A$ |
| $\Delta V_{(BR)DSS}/\Delta T_J$ | Breakdown Voltage Temp. Coefficient | — | 0.030 | — | V/ $^\circ\text{C}$ | Reference to $25^\circ\text{C}, I_D = 1mA$ |
| $R_{DS(on)}$ | Static Drain-to-Source On-Resistance | — | — | 0.030 | Ω | $V_{GS} = 10V, I_D = 4.6A$ ② |
| | | — | — | 0.036 | | $V_{GS} = 4.5V, I_D = 3.9A$ ② |
| $V_{GS(th)}$ | Gate Threshold Voltage | 0.60 | — | 2.0 | V | $V_{DS} = V_{GS}, I_D = 250\mu A$ |
| g_{fs} | Forward Transconductance | 12 | — | — | S | $V_{DS} = 10V, I_D = 4.6A$ |
| I_{DSS} | Drain-to-Source Leakage Current | — | — | 20 | μA | $V_{DS} = 24V, V_{GS} = 0V$ |
| | | — | — | 100 | | $V_{DS} = 24V, V_{GS} = 0V, T_J = 125^\circ\text{C}$ |
| I_{GSS} | Gate-to-Source Forward Leakage | — | — | -200 | nA | $V_{GS} = -12V$ |
| | Gate-to-Source Reverse Leakage | — | — | 200 | | $V_{GS} = 12V$ |
| Q_g | Total Gate Charge | — | 9.0 | — | nC | $I_D = 4.6A$ |
| Q_{gs} | Gate-to-Source Charge | — | 2.5 | — | | $V_{DS} = 24V$ |
| Q_{gd} | Gate-to-Drain ("Miller") Charge | — | 2.6 | — | | $V_{GS} = 4.5V$ ② |
| $t_{d(on)}$ | Turn-On Delay Time | — | 7.2 | — | ns | $V_{DD} = 15V$ |
| t_r | Rise Time | — | 9.1 | — | | $I_D = 1.0A$ |
| $t_{d(off)}$ | Turn-Off Delay Time | — | 25 | — | | $R_G = 6.0\Omega$ |
| t_f | Fall Time | — | 11 | — | | $V_{GS} = 10V$ ② |
| C_{iss} | Input Capacitance | — | 861 | — | pF | $V_{GS} = 0V$ |
| C_{oss} | Output Capacitance | — | 210 | — | | $V_{DS} = 25V$ |
| C_{riss} | Reverse Transfer Capacitance | — | 25 | — | | $f = 1.0MHz$ |

Source-Drain Ratings and Characteristics

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|----------|---|------|------|------|-------|--|
| I_S | Continuous Source Current (Body Diode) | — | — | 0.91 | A | MOSFET symbol showing the integral reverse p-n junction diode.  |
| I_{SM} | Pulsed Source Current (Body Diode) ① | — | — | 37 | | |
| V_{SD} | Diode Forward Voltage | — | — | 1.3 | V | $T_J = 25^\circ\text{C}, I_S = 0.91A, V_{GS} = 0V$ ② |
| t_{rr} | Reverse Recovery Time | — | 25 | — | ns | $T_J = 25^\circ\text{C}, I_F = 0.91A$ |
| Q_{rr} | Reverse Recovery Charge | — | 23 | — | nC | $di/dt = 100A/\mu s$ ② |

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Pulse width $\leq 300\mu s$; duty cycle $\leq 2\%$.
- ③ When mounted on 1 inch square copper board, $t < 10$ sec

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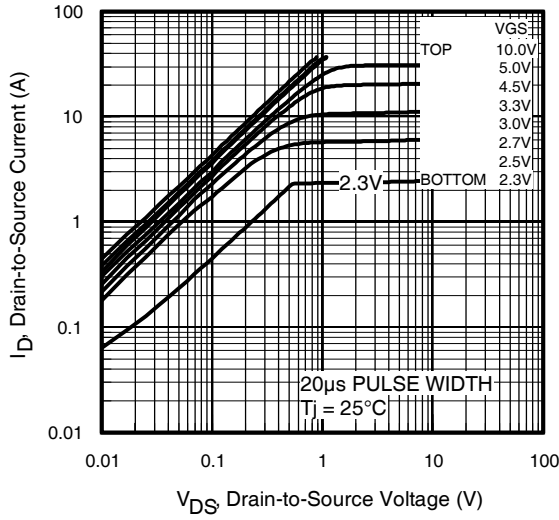


Fig 1. Typical Output Characteristics

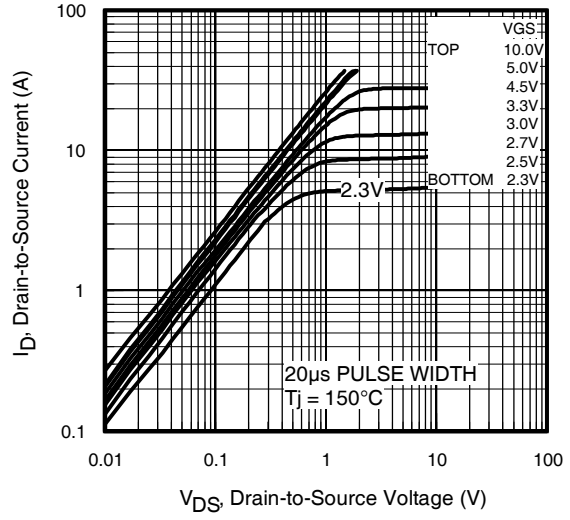


Fig 2. Typical Output Characteristics

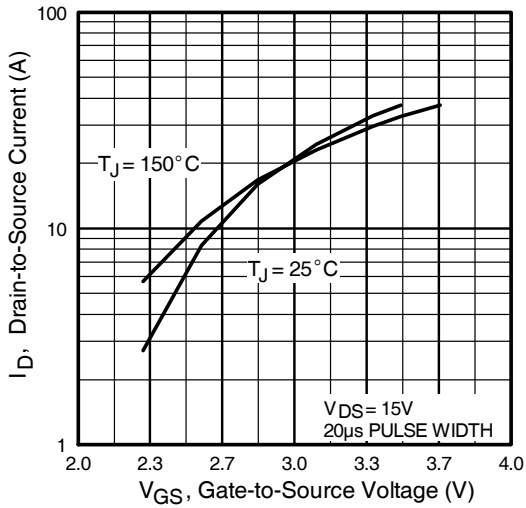


Fig 3. Typical Transfer Characteristics

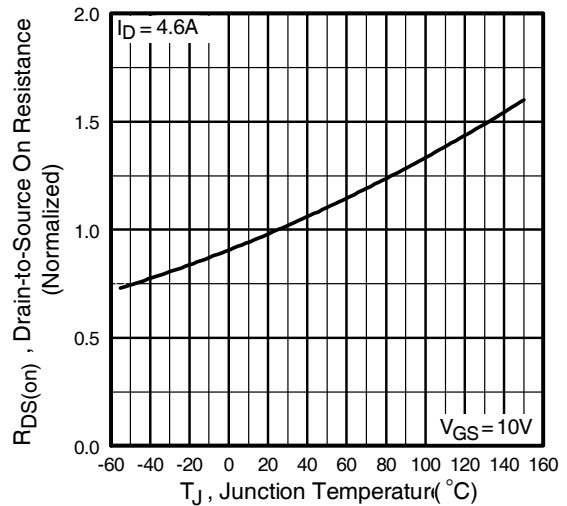


Fig 4. Normalized On-Resistance Vs. Temperature

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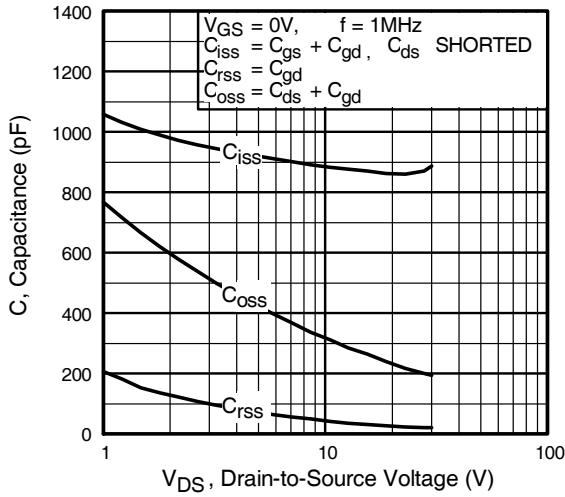


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

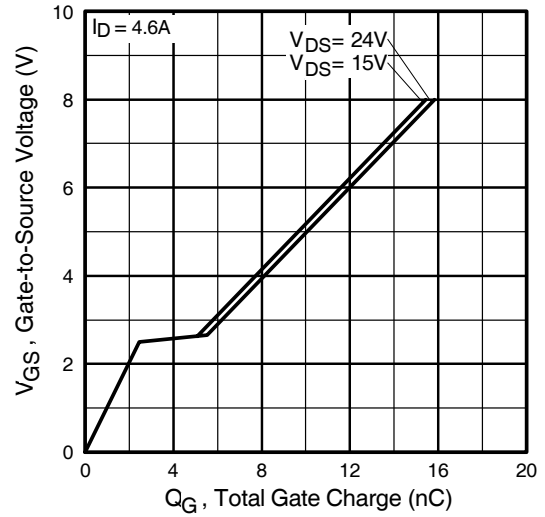


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

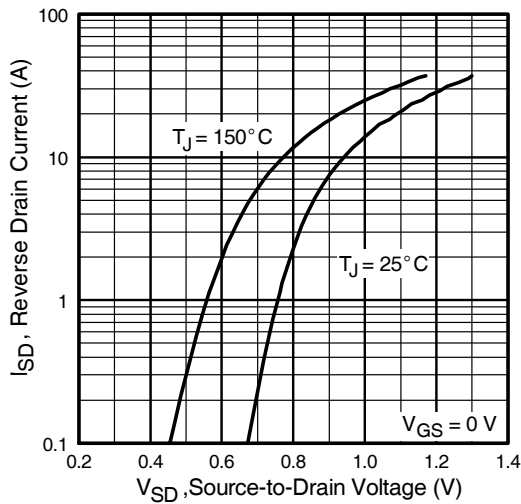


Fig 7. Typical Source-Drain Diode Forward Voltage

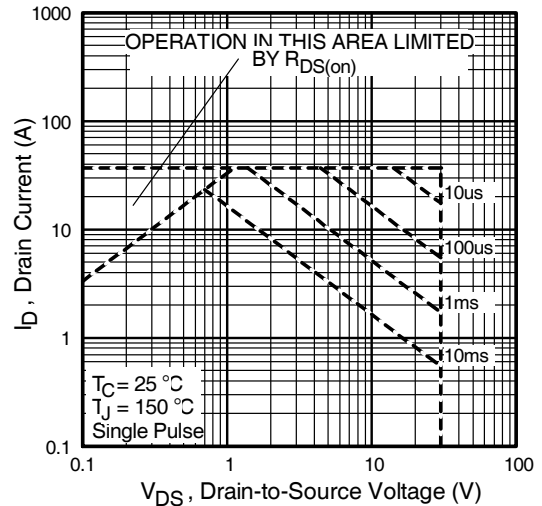


Fig 8. Maximum Safe Operating Area

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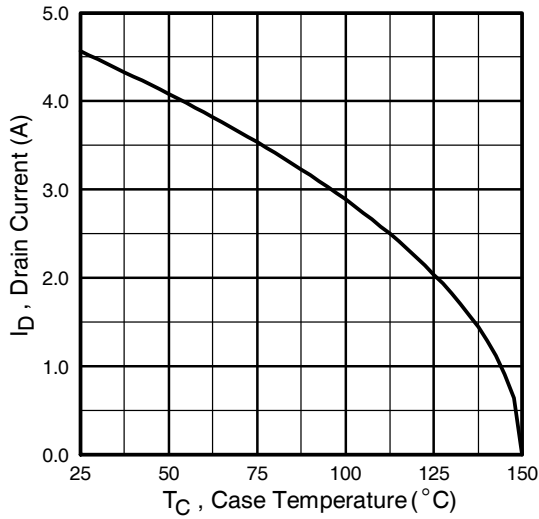


Fig 9. Maximum Drain Current Vs. Case Temperature

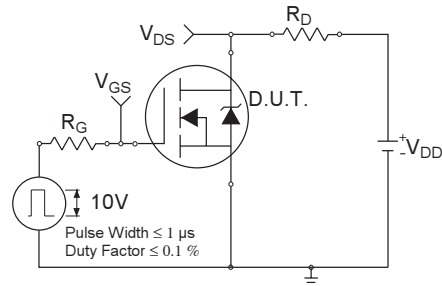


Fig 10a. Switching Time Test Circuit

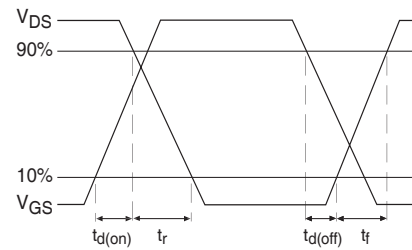


Fig 10b. Switching Time Waveforms

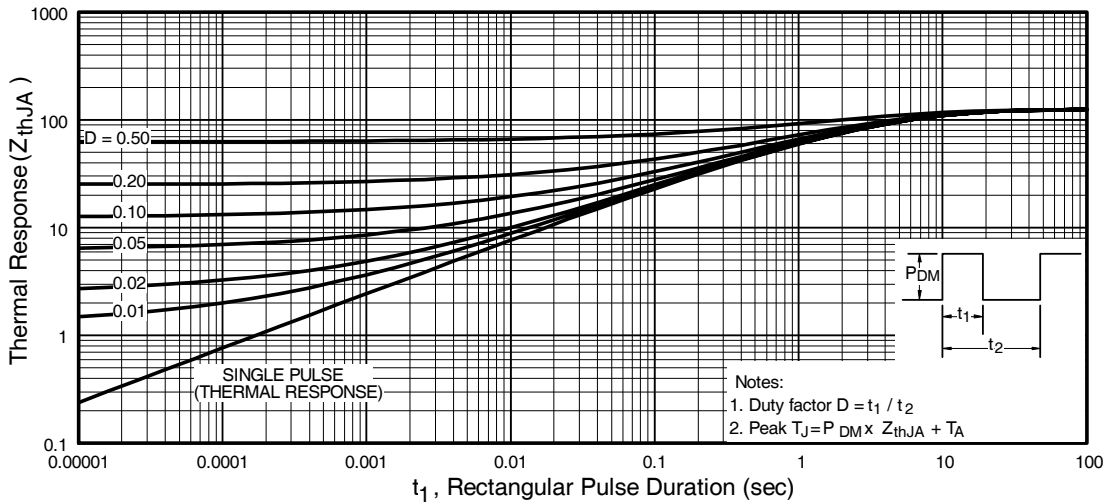


Fig 10. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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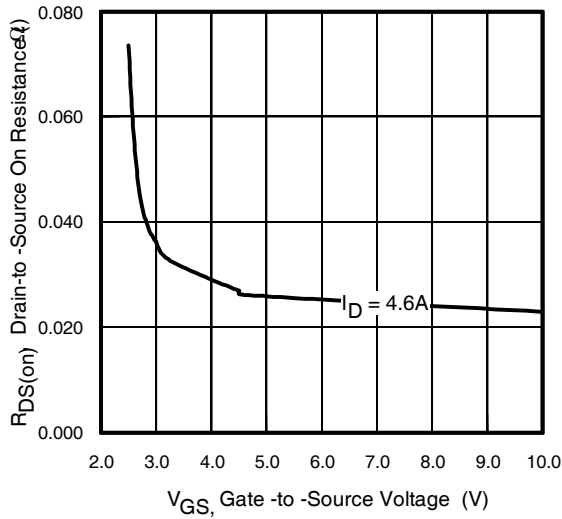


Fig 11. Typical On-Resistance Vs. Gate Voltage

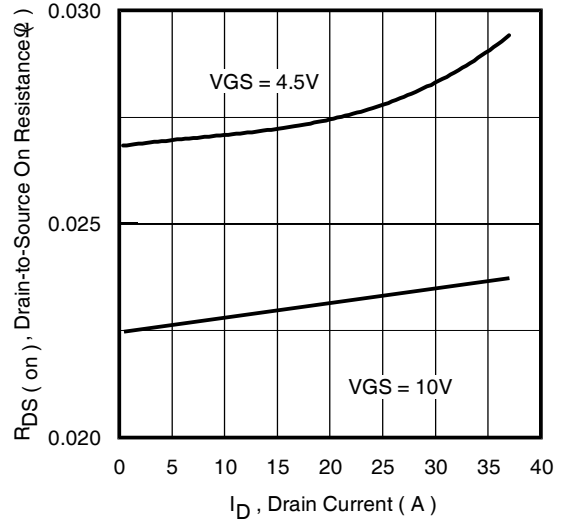


Fig 12. Typical On-Resistance Vs. Drain Current

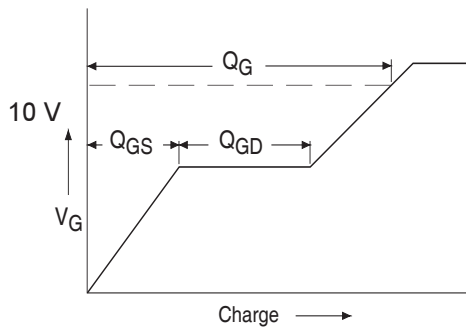


Fig 13a. Basic Gate Charge Waveform

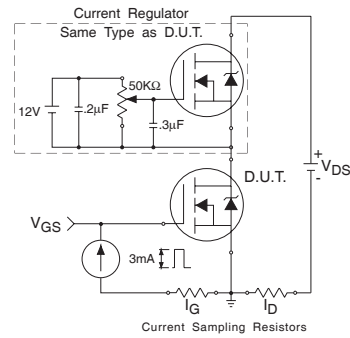


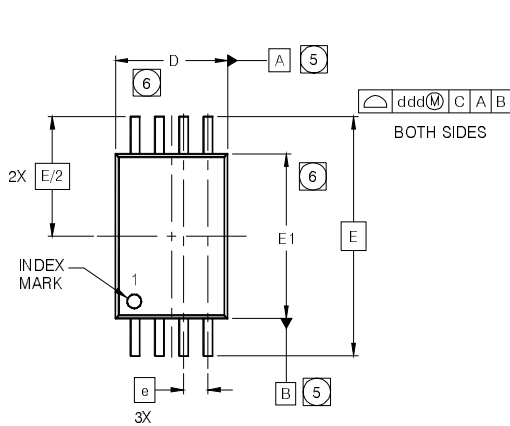
Fig 13b. Gate Charge Test Circuit

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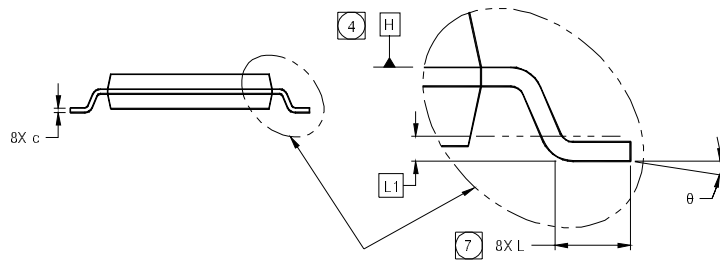
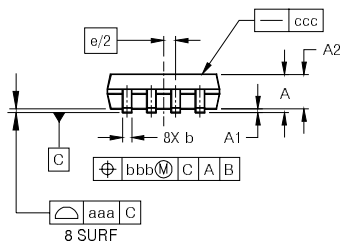
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TSSOP8 Package Outline

Dimensions are shown in millimeters (inches)



| SYMBOL | MO-153AA DIMENSIONS | | | | | |
|--------|---------------------|------|------|----------|-------|-------|
| | MILLIMETERS | | | INCHES | | |
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | --- | --- | 1.20 | --- | --- | .0472 |
| A1 | 0.05 | --- | 0.15 | .0020 | --- | .0059 |
| A2 | 0.80 | 1.00 | 1.05 | .032 | .039 | .041 |
| b | 0.19 | --- | 0.30 | .0075 | --- | .0118 |
| c | 0.09 | --- | 0.20 | .0036 | --- | .0078 |
| D | 2.90 | 3.00 | 3.10 | .115 | .118 | .122 |
| E | 6.40 BSC | | | .251 BSC | | |
| E1 | 4.30 | 4.40 | 4.50 | .170 | .173 | .177 |
| e | 0.65 BSC | | | .0256 | | |
| L | 0.45 | 0.60 | 0.75 | .0178 | .0236 | .0290 |
| L1 | 0.25 BSC | | | .010 BSC | | |
| θ | 0° | --- | 8° | 0° | --- | 8° |
| aaa | 0.10 | | | .0039 | | |
| bbb | 0.10 | | | .0039 | | |
| ccc | 0.05 | | | .0019 | | |
| ddd | 0.20 | | | .0078 | | |



LEAD ASSIGNMENTS



NOTES

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
2. DIMENSIONS ARE SHOWN IN MILLIMETERS AND INCHES.
3. CONTROLLING DIMENSION: MILLIMETER.
4. DATUM PLANE H IS LOCATED AS SHOWN.
5. DATUM A AND B TO BE DETERMINED AT DATUM PLANE H.
6. DIMENSIONS D AND E1 ARE MEASURED AT DATUM PLANE H.
7. DIMENSION L IS THE LEAD LENGTH FOR SOLDERING TO A SUBSTRATE.
8. OUTLINE CONFORMS TO JEDEC OUTLINE MO-153AA.

Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

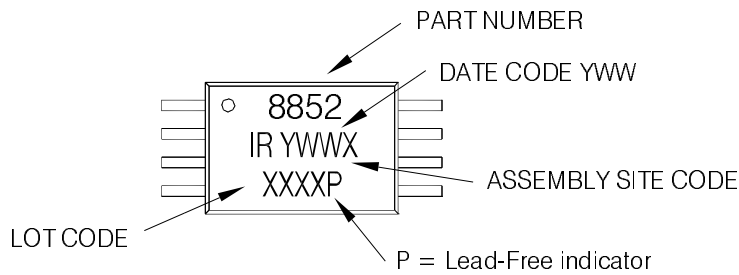
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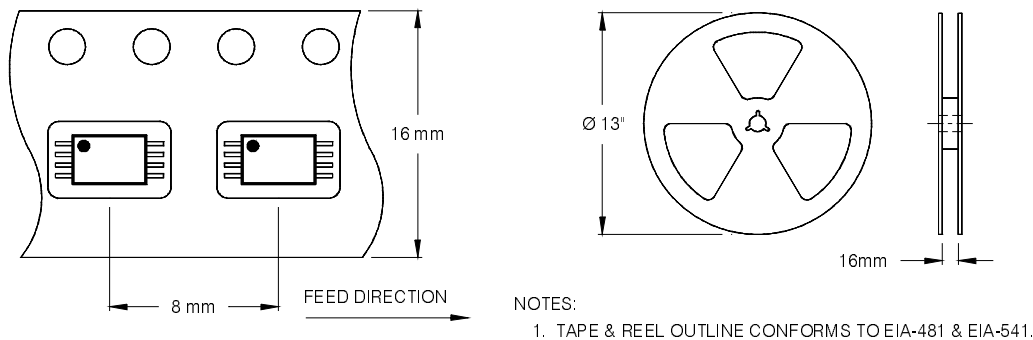
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TSSOP8 Part Marking Information

EXAMPLE: THIS IS AN IRF8852PBF



TSSOP-8 Tape and Reel Information



Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

Data and specifications subject to change without notice.
 This product has been designed and qualified for the Industrial market.
 Qualification Standards can be found on IR's Web site.

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